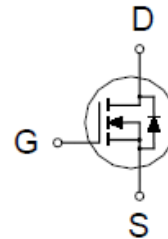
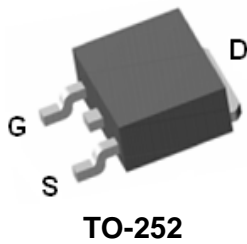


P45N02LDG

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
25V	20m Ω @ $V_{GS} = 10V$	32A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	25	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ¹	$T_C = 25\text{ }^\circ\text{C}$	I_D	32	A
	$T_C = 100\text{ }^\circ\text{C}$		20	
Pulsed Drain Current ²		I_{DM}	110	
Avalanche Current		I_{AS}	23	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	27	mJ
Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	P_D	35	W
	$T_C = 100\text{ }^\circ\text{C}$		14	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		3.6	$^\circ\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		75	
Case-to-Heatsink	$R_{\theta CS}$	0.7		

¹Pulse width limited by maximum junction temperature.

²Limited by package, Duty cycle $\leq 1\%$.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

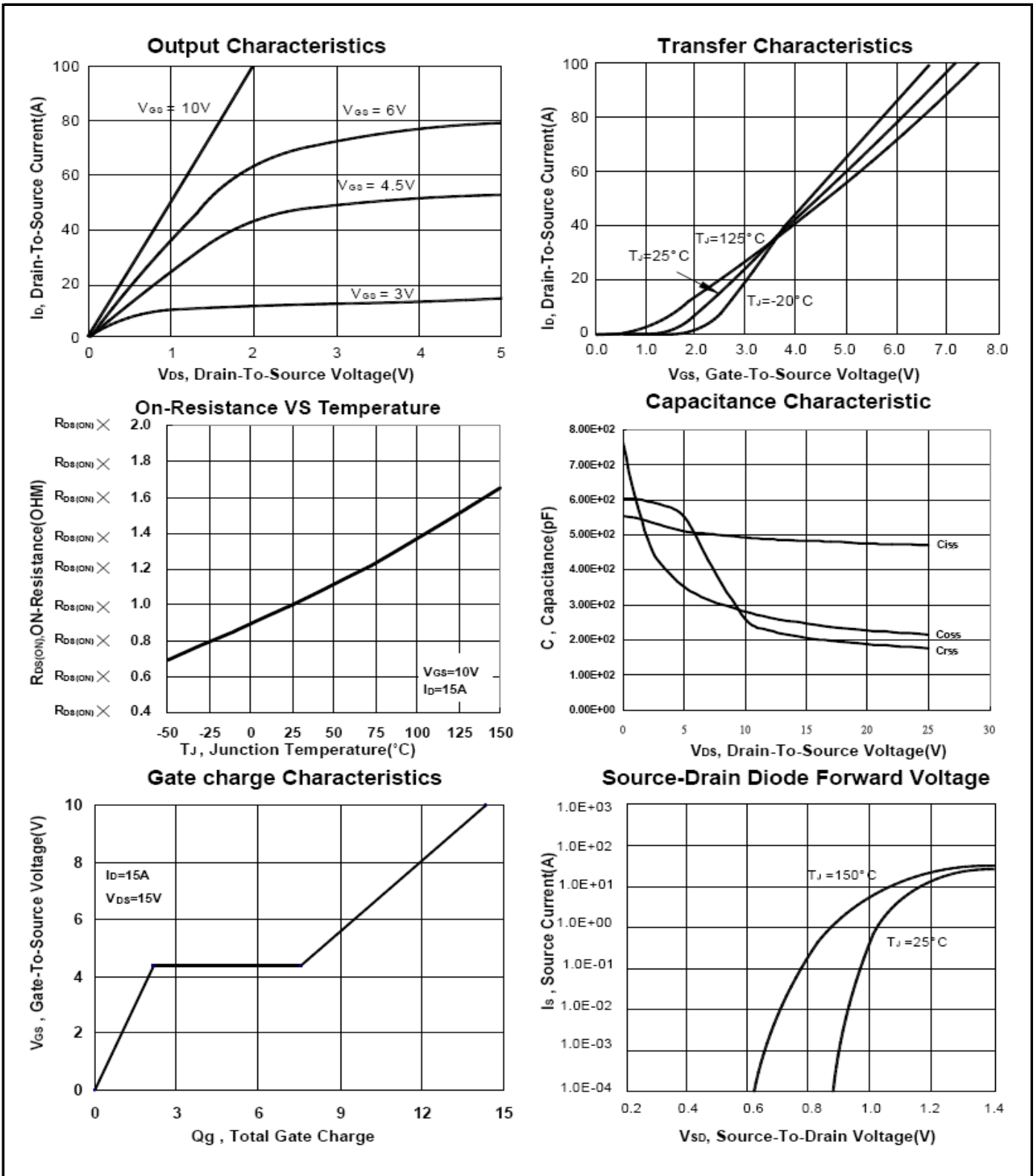
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	25			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.0	1.8	2.5	V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±250	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20V, V _{GS} = 0V			25	μA
		V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C			250	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 10V, V _{GS} = 10V	110			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 10A		29	41	mΩ
		V _{GS} = 10V, I _D = 15A		14	20	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 15A		19		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz		492		pF
Output Capacitance	C _{oss}			221		
Reverse Transfer Capacitance	C _{rss}			187		
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		1.5		Ω
Total Gate Charge ²	Q _{g(VGS=10V)}	V _{DS} = 15V, I _D = 15A		14.7		nC
	Q _{g(VGS=4.5V)}			7.7		
Gate-Source Charge ²	Q _{gs}			2.3		
Gate-Drain Charge ²	Q _{gd}			5.6		
Turn-On Delay Time ²	t _{d(on)}		V _{DD} = 15V, I _D ≅ 15A, V _{GS} = 10V, R _{GS} = 6Ω		10	
Rise Time ²	t _r			17		
Turn-Off Delay Time ²	t _{d(off)}			34		
Fall Time ²	t _f			27		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I _S				25	A
Forward Voltage ¹	V _{SD}	I _F = 15A, V _{GS} = 0V			1.4	V
Reverse Recovery Time	t _{rr}	I _F = 15A, dI _F /dt = 100A / μS		27		nS
Reverse Recovery Charge	Q _{rr}				36	

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

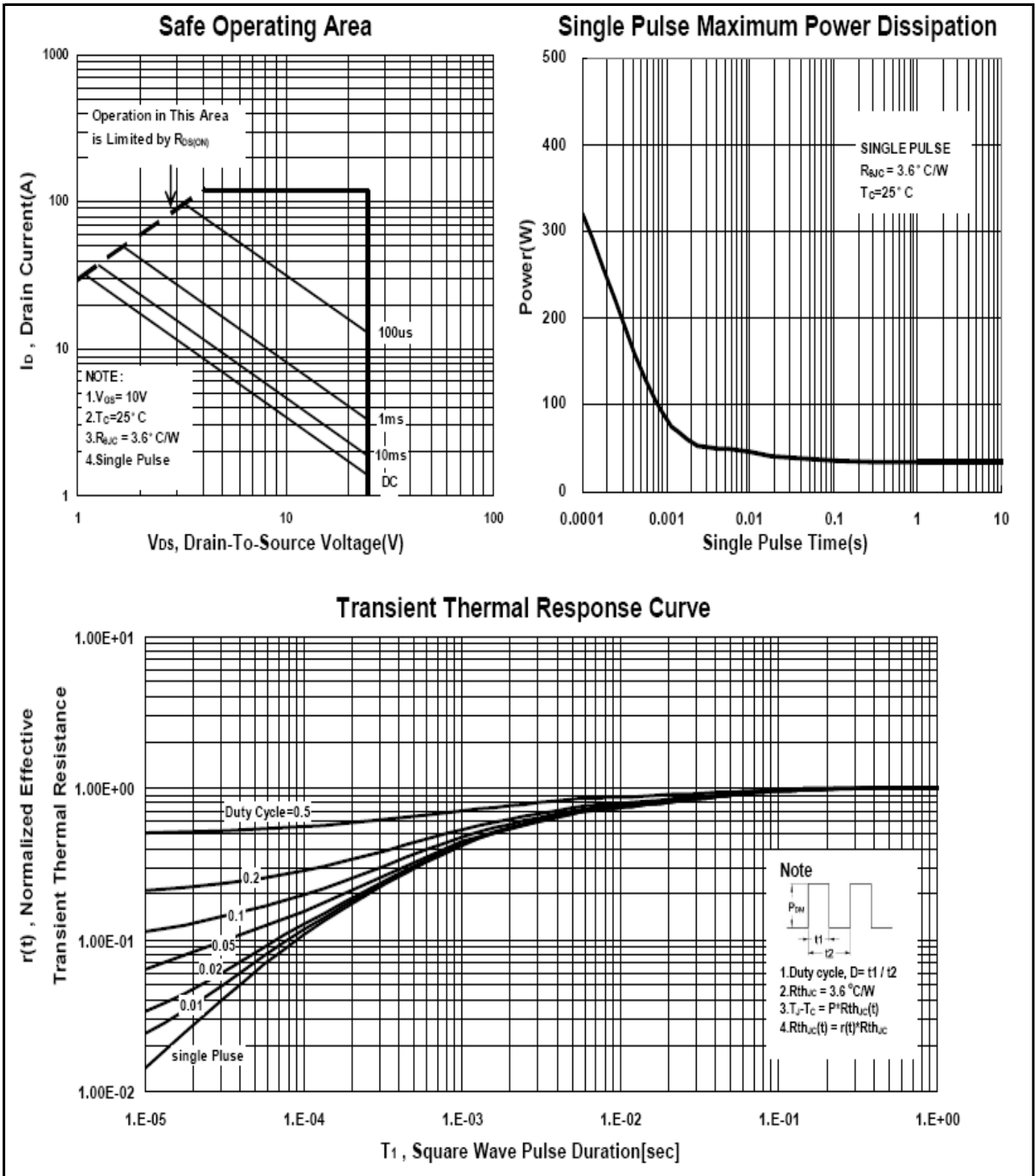
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Package Dimension

TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	10	10.41	J	4.8		5.64
B	2.1	2.2	2.5	K	0.15		1.49
C	0.4	0.5	0.61	L	0.4	0.76	0.91
D	0.82	1.2	1.5	M	4.2	4.58	5
E	0.35	0.5	0.65	S	4.57	5.1	5.52
F	0		0.2	T	3.81	4.75	5.24
G	5.3	6.1	6.3	U	1.4		1.78
H	0.5		1.7	V	0.55	1.25	1.7
I	6.3	6.5	6.8				

